IHM-B module with Trench/Fieldstop IGBT3 and emitter controlled 3 diode


Typical appearance

Features

- Electrical features
  - V_{CES} = 3300 V
  - $I_{C\ nom}$ = 1500 A / I_{CRM} = 3000 A
  - High DC stability
  - High short-circuit capability
  - Low $V_{CE,sat}$
  - Unbeatable robustness
  - $T_{vj,op}$ = 150°C
  - $V_{CE,sat}$ with positive temperature coefficient
- Mechanical features
  - AlSiC base plate for increased thermal cycling capability
  - Package with CTI > 600
  - IHM B housing
  - Isolated base plate

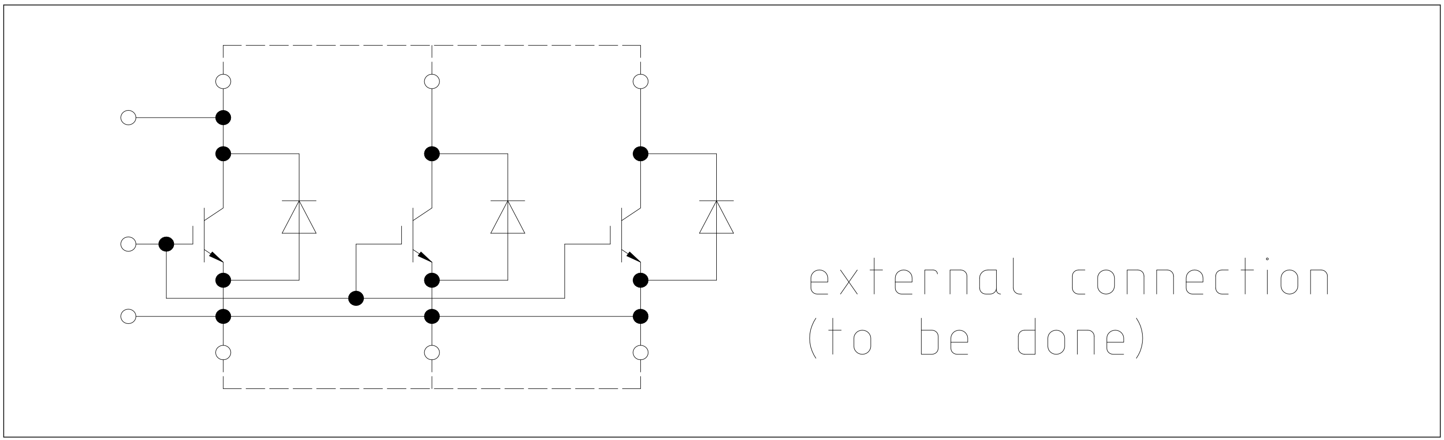
Potential applications

- Chopper applications
- Medium-voltage converters
- Motor drives
- Traction drives
- UPS systems
- Wind turbines

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description



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1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, f = 50 Hz, t = 1 min	6.0	kV
Partial discharge extinction voltage	V_{isol}	RMS, f = 50 Hz, $Q_{PD} \leq 10$ pC	2.6	kV
DC stability	$V_{CE(D)}$	T_{vj}=25°C, 100 Fit	2100	V
Material of module baseplate			AlSiC	
Internal isolation		basic insulation (class 1, IEC 61140)	-	
Creepage distance	d_{Creep}	terminal to heatsink	32.2	mm
Clearance	d_{Clear}	terminal to heatsink	19.1	mm
Comparative tracking index	CTI		>600	

Table 2 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Thermal resistance, case to heat sink	R_{thCH}	per module, λ_{Paste}= 1 W /(m*K) / λ_{grease}= 1 W/(m*K)			5.5		K/kW
Stray inductance module	L_{sCE}				6		nH
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	T_C=25°C, per switch			0.12		mΩ
Storage temperature	T_{stg}			-40		150	°C
Mounting torque for module mounting	M	- Mounting according to valid application note	M6, Screw	4.25		5.75	Nm
Terminal connection torque	M	- Mounting according to valid application note	M4, Screw	1.8		2.1	Nm
			M8, Screw	8		10	
Weight	G				1200		g

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		T_{vj} = -40 °C	3300	V
			T_{vj} = 150 °C	3300	
Continuous DC collector current	I_{CDC}	$T_{vj\,max}$ = 150 °C	T_C = 95 °C	1500	A
Repetitive peak collector current	I_{CRM}	t_P = 1 ms		3000	A

(table continues...)

Table 3 (continued) Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Gate-emitter peak voltage	V_{GES}		±20	V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition		Values Min.	Typ.	Max.	Unit
Collector-emitter saturation voltage	$V_{CE\,sat}$	I_C = 1500 A, V_{GE} = 15 V	T_{vj} = 25 °C		2.40	2.85	V
			T_{vj} = 125 °C		2.95	3.50	
			T_{vj} = 150 °C		3.10		
Gate threshold voltage	V_{GEth}	I_C = 72 mA, V_{CE} = V_{GE}, T_{vj} = 25 °C		5.20	5.80	6.40	V
Gate charge	Q_G	V_{GE} = ±15 V, V_{CE} = 1800 V			42		µC
Internal gate resistor	R_{Gint}	T_{vj} = 25 °C			0.42		Ω
Input capacitance	C_{ies}	f = 1000 kHz, T_{vj} = 25 °C, V_{CE} = 25 V, V_{GE} = 0 V			280		nF
Reverse transfer capacitance	C_{res}	f = 1000 kHz, T_{vj} = 25 °C, V_{CE} = 25 V, V_{GE} = 0 V			6		nF
Collector-emitter cut-off current	I_{CES}	V_{CE} = 3300 V, V_{GE} = 0 V	T_{vj} = 25 °C			5	mA
Gate-emitter leakage current	I_{GES}	V_{CE} = 0 V, V_{GE} = 20 V, T_{vj} = 25 °C				400	nA
Turn-on delay time (inductive load)	t_{don}	I_C = 1500 A, V_{CE} = 1800 V, V_{GE} = ±15 V, R_{Gon} = 0.51 Ω, C_{GE} = 330 nF	T_{vj} = 25 °C		0.360		µs
			T_{vj} = 125 °C		0.400		
			T_{vj} = 150 °C		0.410		
Rise time (inductive load)	t_r	I_C = 1500 A, V_{CE} = 1800 V, V_{GE} = ±15 V, R_{Gon} = 0.51 Ω, C_{GE} = 330 nF	T_{vj} = 25 °C		0.370		µs
			T_{vj} = 125 °C		0.400		
			T_{vj} = 150 °C		0.400		
Turn-off delay time (inductive load)	t_{doff}	I_C = 1500 A, V_{CE} = 1800 V, V_{GE} = ±15 V, R_{Goff} = 2.7 Ω, C_{GE} = 330 nF	T_{vj} = 25 °C		4.100		µs
			T_{vj} = 125 °C		4.300		
			T_{vj} = 150 °C		4.300		
Fall time (inductive load)	t_f	I_C = 1500 A, V_{CE} = 1800 V, V_{GE} = ±15 V, R_{Goff} = 2.7 Ω, C_{GE} = 330 nF	T_{vj} = 25 °C		0.400		µs
			T_{vj} = 125 °C		0.400		
			T_{vj} = 150 °C		0.400		
Turn-on time (resistive load)	t_{on_R}	I_C = 500 A, V_{CE} = 2000 V, V_{GE} = ±15 V, R_{Gon} = 0.51 Ω, C_{GE} = 330 nF	T_{vj} = 25 °C	1.35			µs

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Turn-on energy loss per pulse	E_{on}	I_C = 1500 A, V_{CE} = 1800 V, L_σ = 85 nH, V_{GE} = ±15 V, R_{Gon} = 0.51 Ω, C_{GE} = 330 nF, di/dt = 4300 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		2300		mJ
			T_{vj} = 125 °C		3200		
			T_{vj} = 150 °C		3600		
Turn-off energy loss per pulse	E_{off}	I_C = 1500 A, V_{CE} = 1800 V, L_σ = 85 nH, V_{GE} = ±15 V, R_{Goff} = 2.7 Ω, C_{GE} = 330 nF, dv/dt = 1550 V/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		2400		mJ
			T_{vj} = 125 °C		2950		
			T_{vj} = 150 °C		3100		
SC data	I_{SC}	V_{GE} ≤ 15 V, V_{CC} = 2500 V, V_{CEmax}=V_{CES}-L_{sCE}*di/dt	t_P ≤ 10 µs, T_{vj}=150 °C		6400		A
Thermal resistance, junction to case	R_{thJC}	per IGBT				7.35	K/kW
Thermal resistance, case to heat sink	R_{thCH}	per IGBT, λ_{grease}= 1 W/(m*K)			10.0		K/kW
Temperature under switching conditions	$T_{vj\ op}$			-40		150	°C

3 Diode, Inverter

Table 5 Maximum rated values

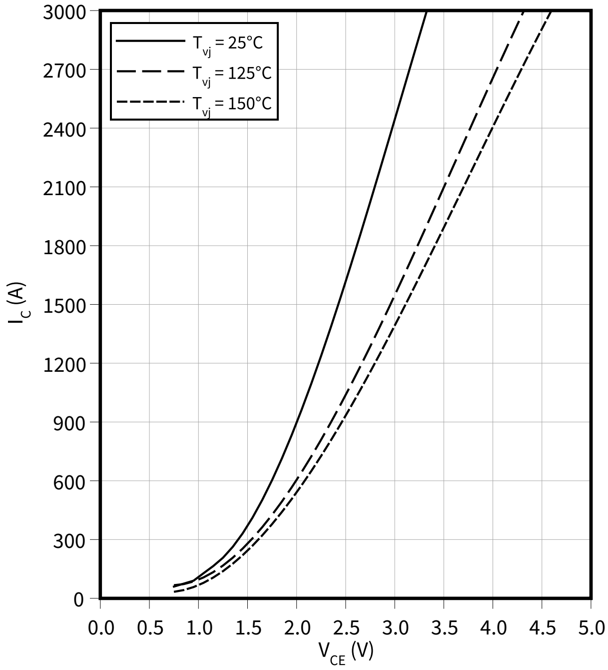
Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		T_{vj} = -40 °C	3300	V
			T_{vj} = 150 °C	3300	
Continuous DC forward current	I_F			1500	A
Repetitive peak forward current	I_{FRM}	t_P = 1 ms		3000	A
I^2t - value	I^2t	t_P = 10 ms, V_R = 0 V	T_{vj} = 125 °C	845	kA^2s
			T_{vj} = 150 °C	730	
Maximum power dissipation	P_{RQM}	T_{vj} = 150 °C		2400	kW
Minimum turn-on time	t_{onmin}			10	µs

Table 6 **Characteristic values**

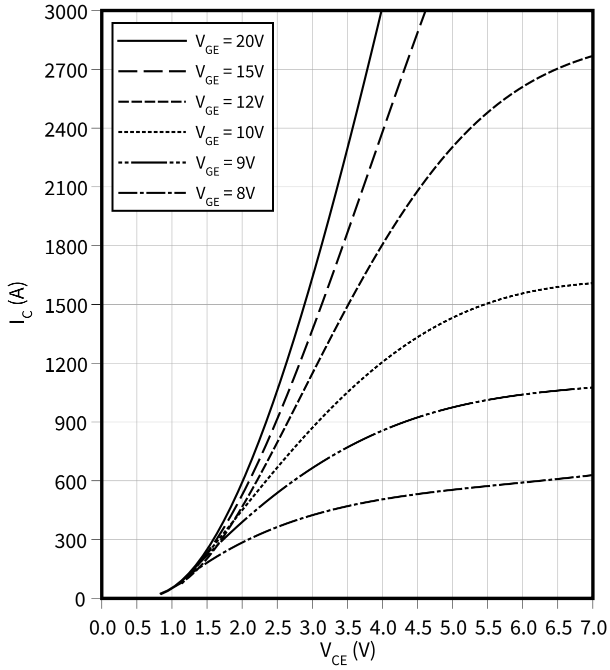
Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Forward voltage	V_F	I_F = 1500 A, V_{GE} = 0 V	T_{vj} = 25 °C		2.25	2.85	V
			T_{vj} = 125 °C		2.20	2.75	
			T_{vj} = 150 °C		2.20		
Peak reverse recovery current	I_{RM}	V_R = 1800 V, I_F = 1500 A, V_{GE} = -15 V, -di_F/dt = 4300 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		1600		A
			T_{vj} = 125 °C		1800		
			T_{vj} = 150 °C		1900		
Recovered charge	Q_r	V_R = 1800 V, I_F = 1500 A, V_{GE} = -15 V, -di_F/dt = 4300 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		1500		µC
			T_{vj} = 125 °C		2600		
			T_{vj} = 150 °C		2900		
Reverse recovery energy	E_{rec}	V_R = 1800 V, I_F = 1500 A, V_{GE} = -15 V, -di_F/dt = 4300 A/µs (T_{vj} = 150 °C)	T_{vj} = 25 °C		1600		mJ
			T_{vj} = 125 °C		3150		
			T_{vj} = 150 °C		3700		
Thermal resistance, junction to case	R_{thJC}	per diode				13.0	K/kW
Thermal resistance, case to heat sink	R_{thCH}	per diode, λ_{grease}= 1 W/(m*K)			11.0		K/kW
Temperature under switching conditions	$T_{vj\ op}$			-40		150	°C

4 Characteristics diagrams

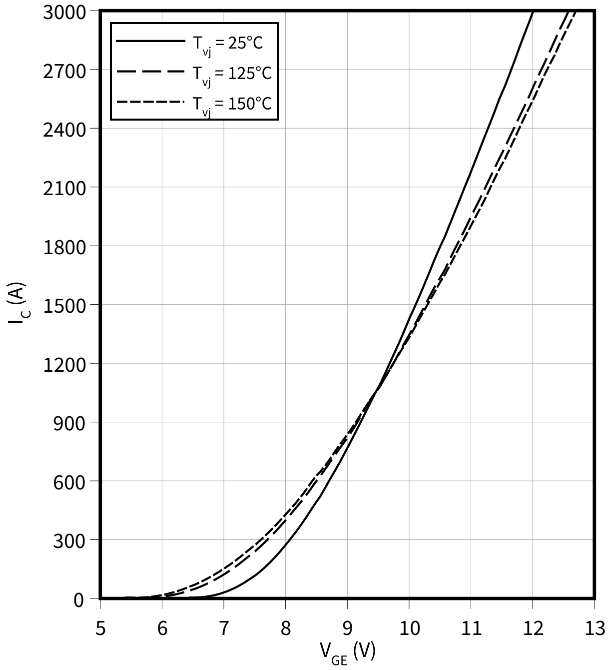
output characteristic (typical), IGBT, Inverter
$I_C = f(V_{CE})$
$V_{GE} = 15$ V



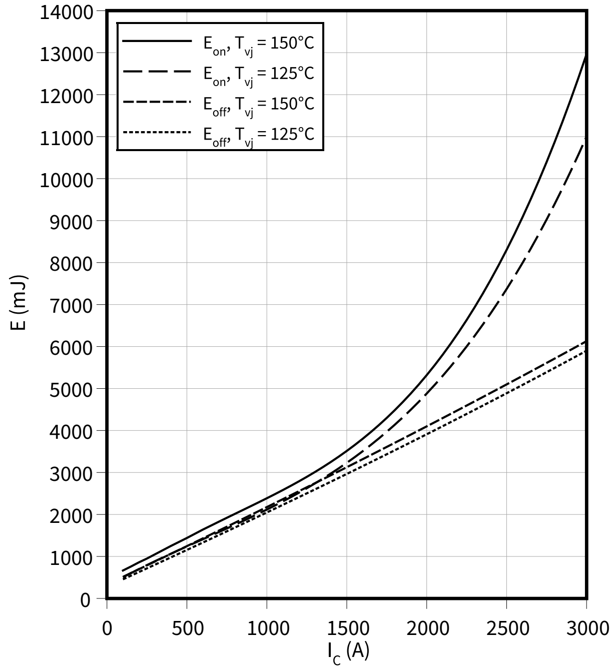
output characteristic (typical), IGBT, Inverter
$I_C = f(V_{CE})$
$T_{vj} = 150$ °C



transfer characteristic (typical), IGBT, Inverter
$I_C = f(V_{GE})$
$V_{CE} = 20$ V



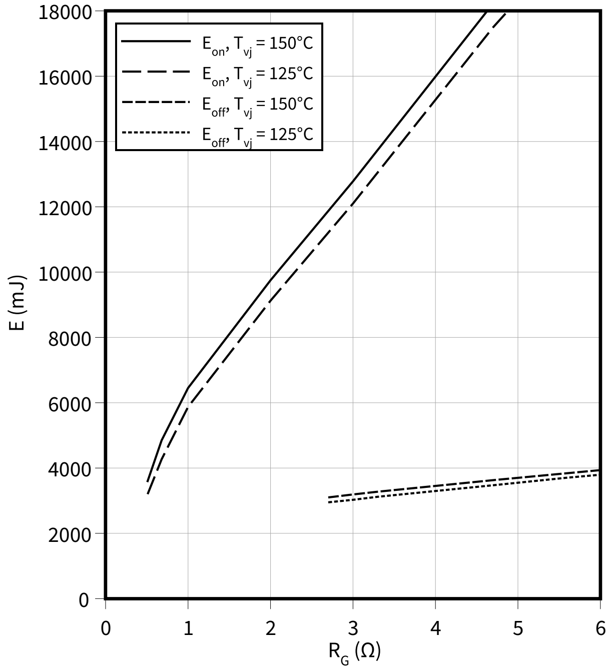
switching losses (typical), IGBT, Inverter
$E = f(I_C)$
$R_{Goff} = 2.7\ \Omega$, $R_{Gon} = 0.51\ \Omega$, $C_{GE} = 330$ nF, $V_{CE} = 1800$ V, $V_{GE} = \pm 15$ V



switching losses (typical), IGBT, Inverter

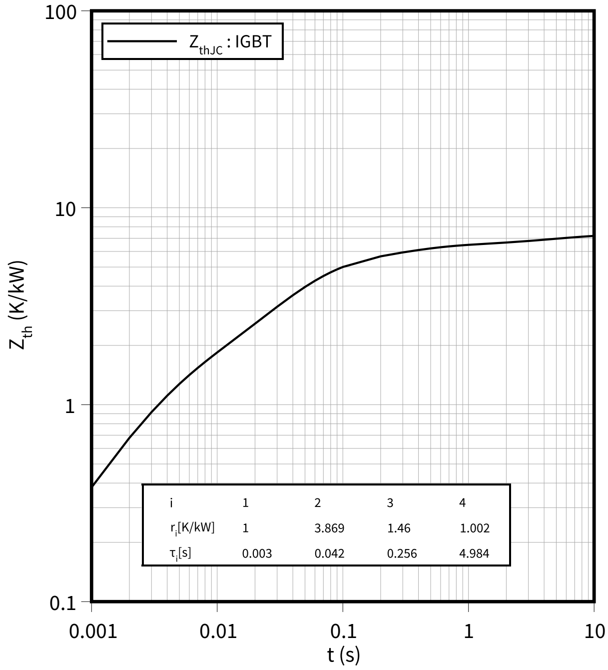
$E = f(R_G)$

I_C = 1500 A, C_{GE} = 330 nF, V_{CE} = 1800 V, V_{GE} = ± 15 V



transient thermal impedance , IGBT, Inverter

$Z_{th} = f(t)$

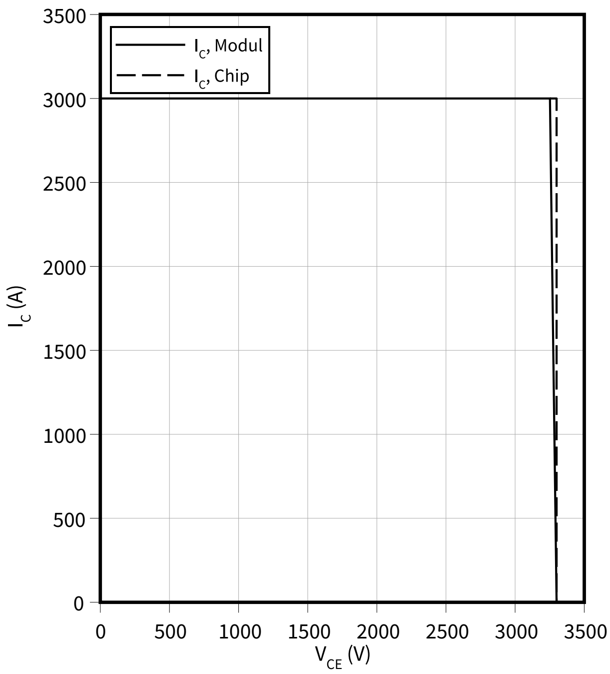


i	1	2	3	4
r_i[K/kW]	1	3.869	1.46	1.002
τ_i[s]	0.003	0.042	0.256	4.984

reverse bias safe operating area (RBSOA), IGBT, Inverter

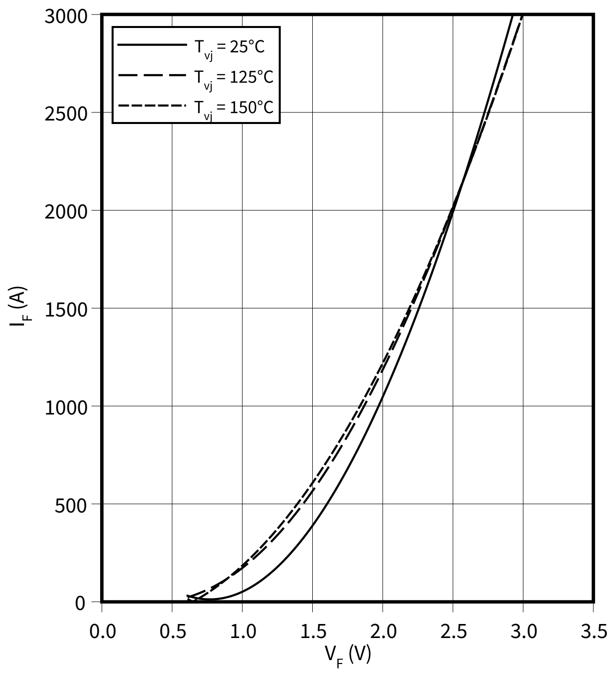
$I_C = f(V_{CE})$

C_{GE} = 330 nF, T_{vj} = 150 °C, R_{Goff} = 2.7 Ω, V_{GE} = ±15 V



forward characteristic of (typical), Diode, Inverter

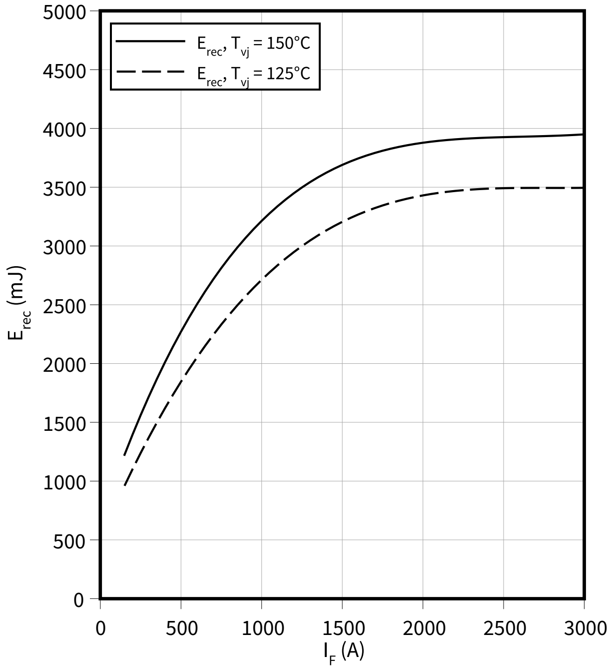
$I_F = f(V_F)$



switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$

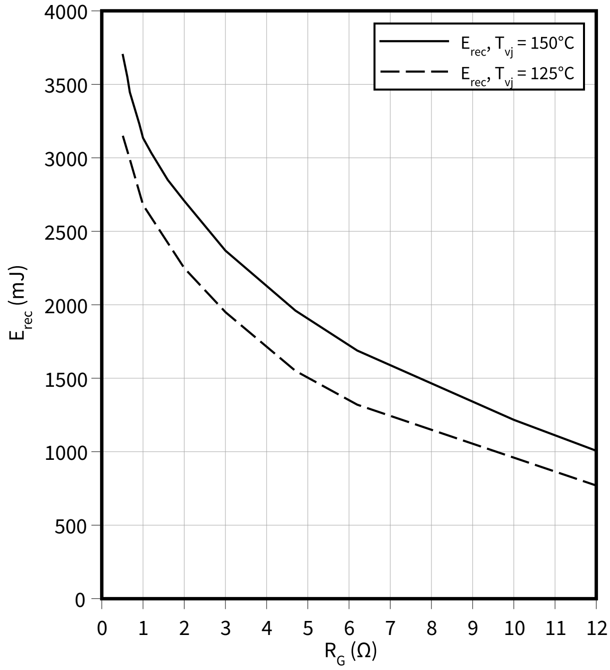
$V_{CE} = 1800$ V, $R_{Gon} = R_{Gon}$(IGBT)



switching losses (typical), Diode, Inverter

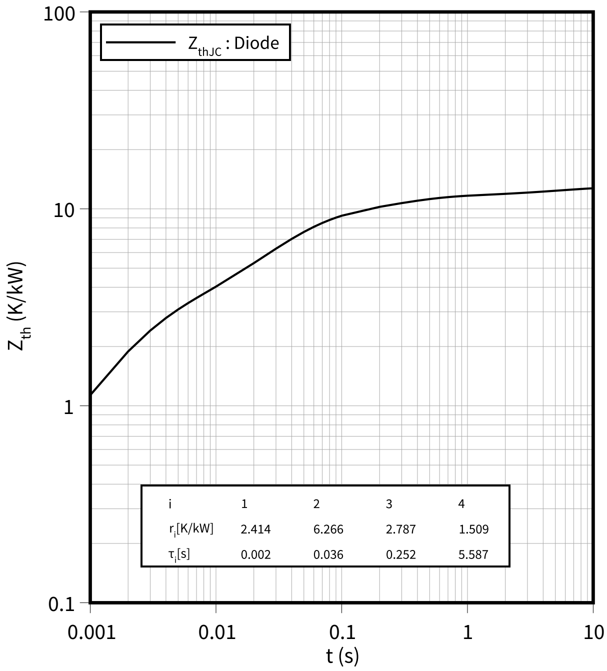
$E_{rec} = f(R_G)$

$V_{CE} = 1800$ V, $I_F = 1500$ A



transient thermal impedance , Diode, Inverter

$Z_{th} = f(t)$

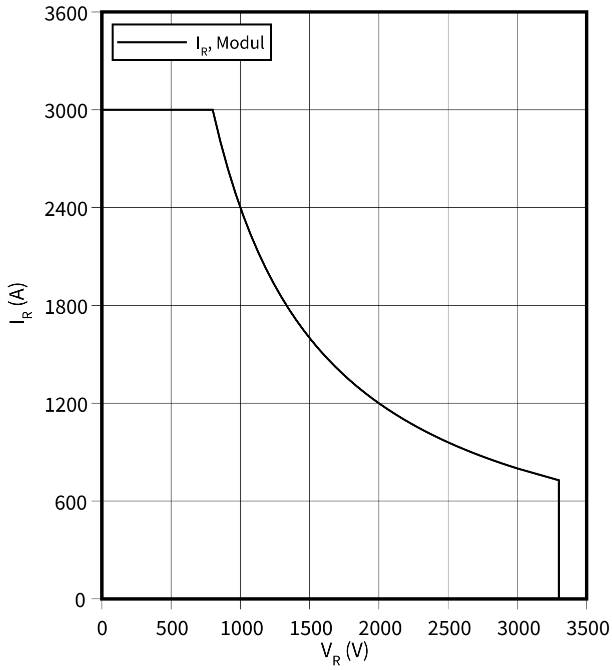


i	1	2	3	4
r_i[K/kW]	2.414	6.266	2.787	1.509
τ_i[s]	0.002	0.036	0.252	5.587

safe operation area (SOA), Diode, Inverter

$I_R = f(V_R)$

$T_{vj} = 150$ °C



5 Circuit diagram

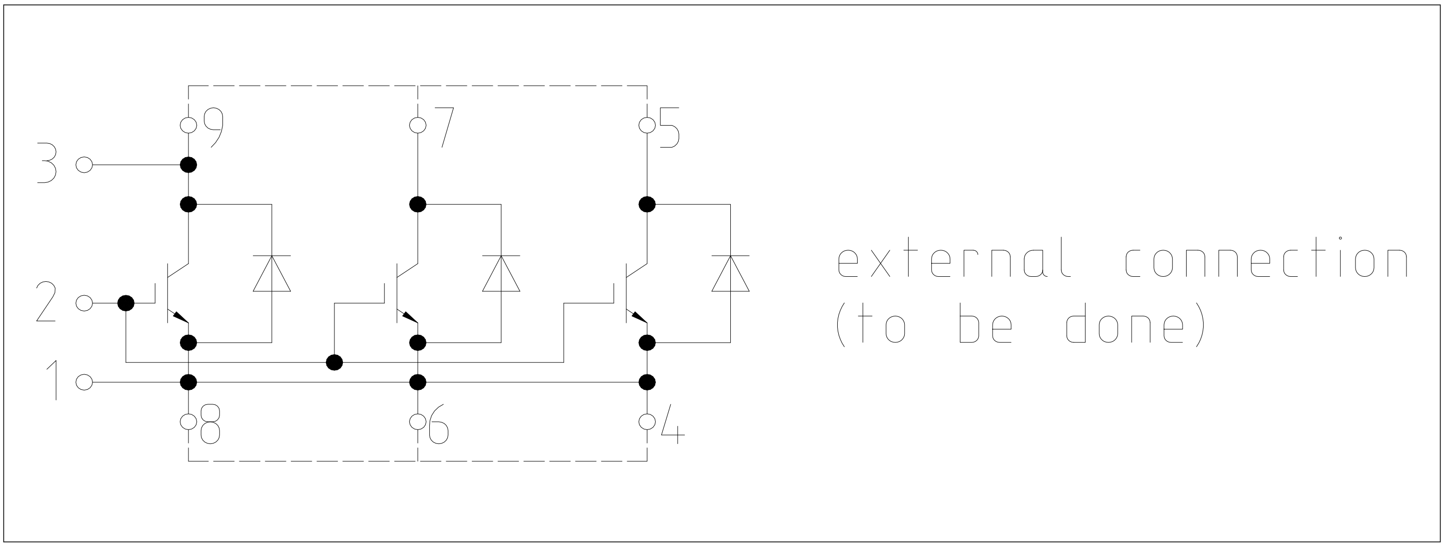


Figure 1

6 Package outlines

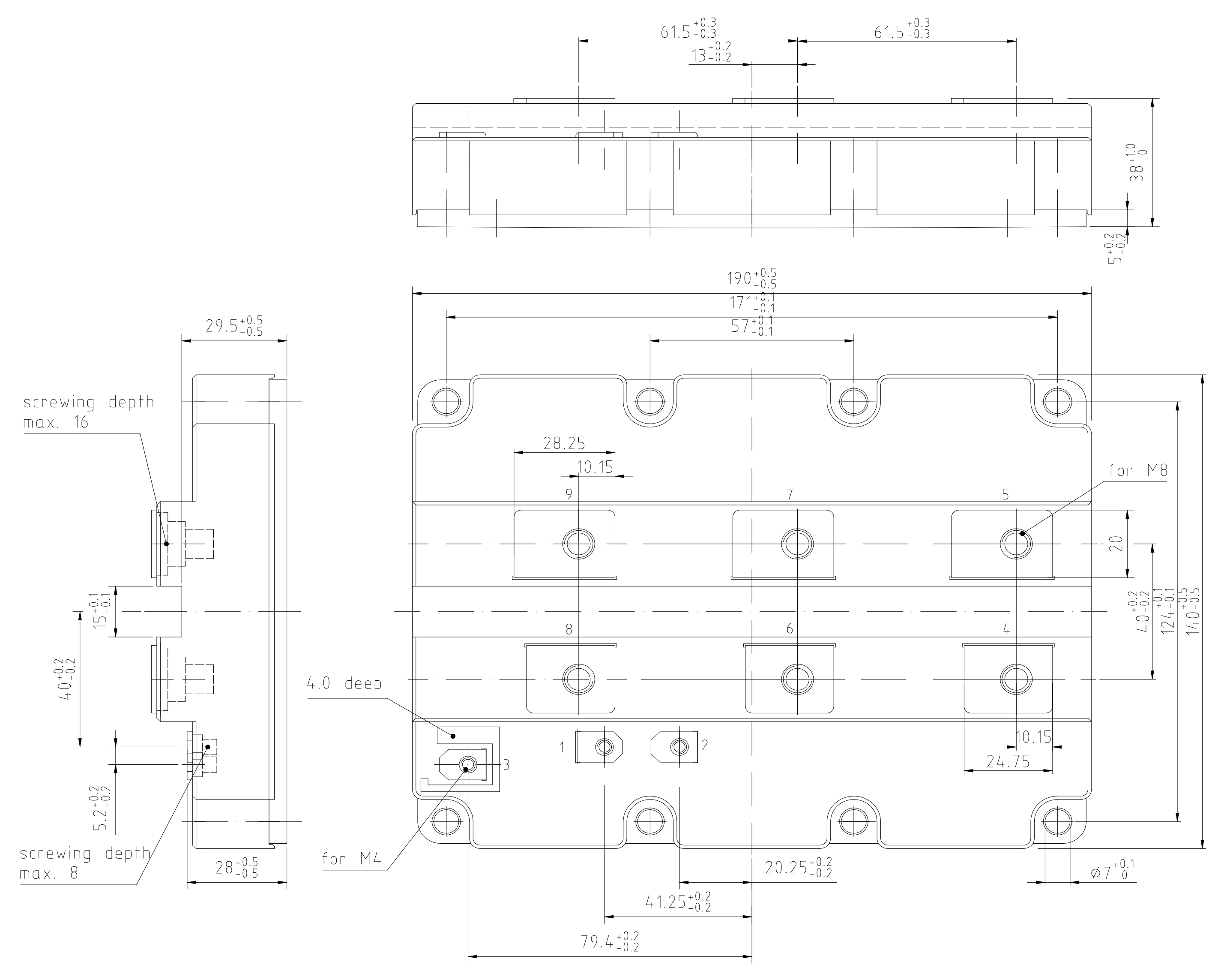


Figure 2

7 Module label code

Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	*Content* Module serial number Module material number Production order number Date code (production year) Date code (production week)	*Digit* 1 – 5 6 - 11 12 - 19 20 – 21 22 – 23	*Example* 71549 142846 55054991 15 30
Example	71549142846550549911530		71549142846550549911530

Figure 3

Revision history

Document revision	Date of release	Description of changes
V2.1	2007-02-18	Preliminary datasheet
V2.2	2007-09-21	Preliminary datasheet
V2.3	2008-02-06	Preliminary datasheet
V2.4	2010-04-26	Preliminary datasheet
V3.0	2013-08-09	Final datasheet
V3.1	2013-12-11	Final datasheet
V3.2	2018-07-12	Final datasheet
V3.3	2019-07-24	Final datasheet
n/a	2020-09-01	Datasheet migrated to a new system with a new layout and new revision number schema: target or preliminary datasheet = 0.xy; final datasheet = 1.xy
1.10	2021-10-26	Final datasheet